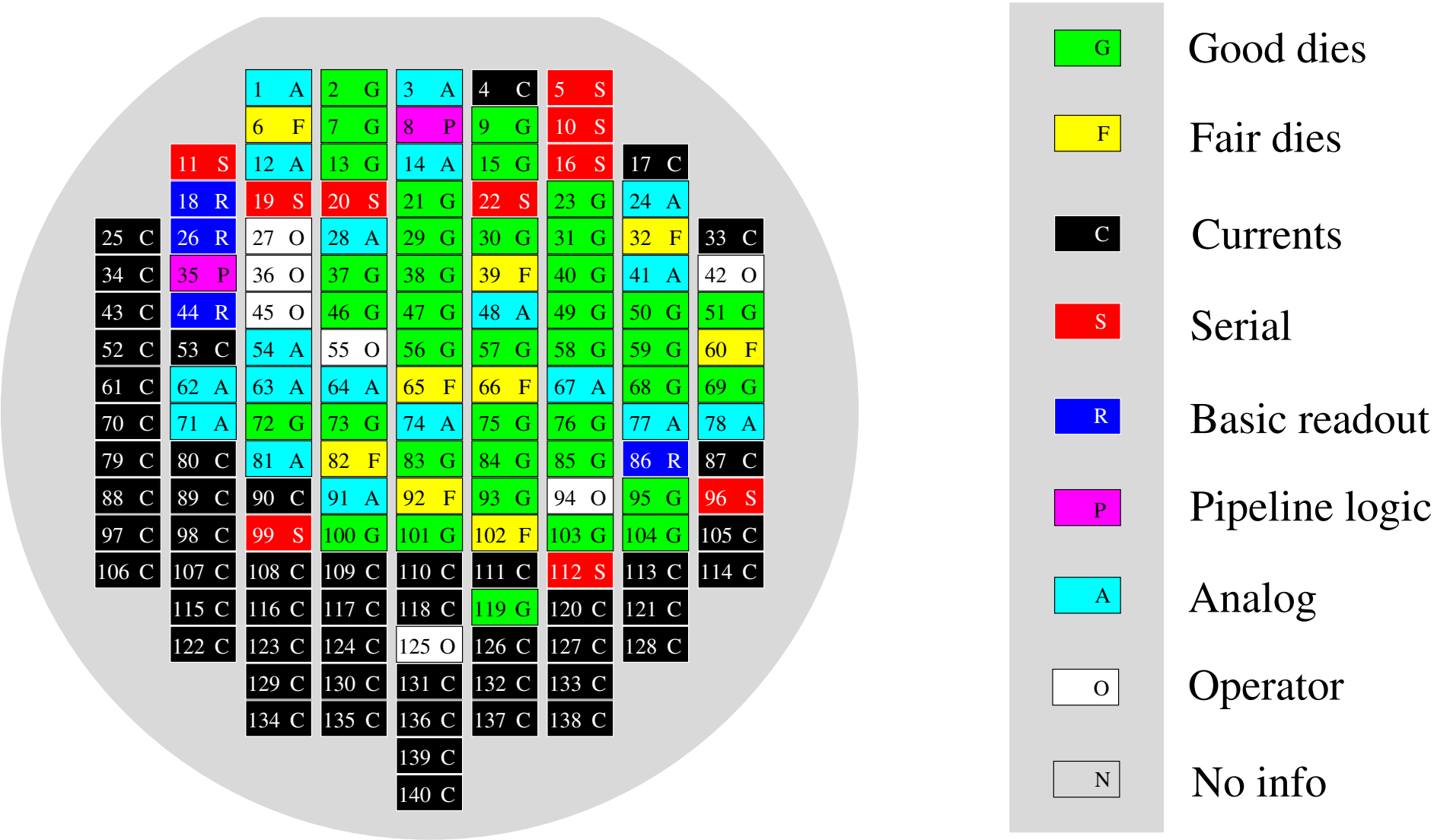
Types of die failures for wafer 157 s/n: Y21316-08-18

Date: 06/22/99